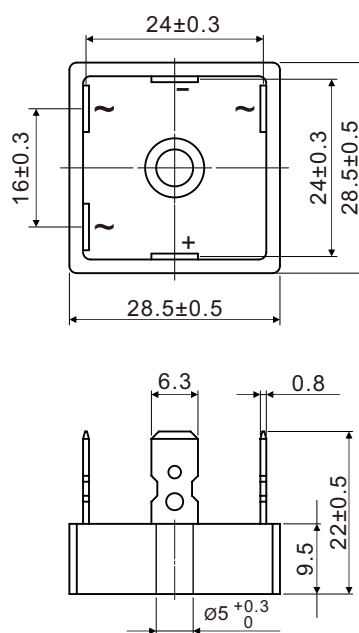


Glass Passivated Triple-Phase Bridge Rectifier, 35A

MTP3506A1 Thru MTP3516A1



All dimensions in millimeters

FEATURES

- UL recognition file number E320098
- Universal 3-way terminals: snap-on, wire wrap-around, or PCB mounting
- Typical IR less than $1.0 \mu\text{A}$
- High surge current capability
- Low thermal resistance
- Solder dip 260°C , 40s
- Compliant to RoHS
- Glass passivated chips

TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for big power supply, field supply for DC motor, industrial automation applications.

MECHANICAL DATA

Case: GBPC

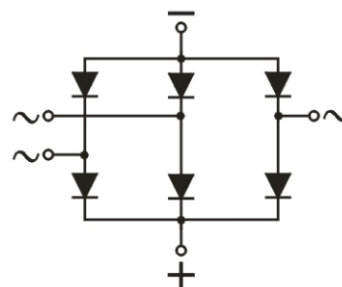
Epoxy meets UL 94 V-O flammability rating

Terminals: Gold plated on faston lugs or gold plated on wire leads, solderable per J-STD-002 and JESD22-B102.

Polarity: As marked

Mounting Torque: 20 inches-lbs.max.

Weight: 21g (0.74 ozs)



PRIMARY CHARACTERISTICS

$I_{F(AV)}$	35A
V_{RRM}	600V to 1600V
I_{FSM}	450A
I_R	$5 \mu\text{A}$
V_F	1.2V
$T_{J \text{ max.}}$	150°C

MAJOR RATINGS AND CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	SYMBOL	MTP35..A1					UNIT
		06	08	10	12	16	
Maximum repetitive peak reverse voltage	V_{RRM}	600	800	1000	1200	1600	V
Maximum RMS voltage	V_{RMS}	420	560	700	840	1120	V
Maximum DC blocking voltage	V_{DC}	600	800	1000	1200	1600	V
Maximum average forward rectified output current (Fig.1)	$I_{F(AV)}$	35					A
Peak forward surge current single sine-wave superimposed on rated load	I_{FSM}	450					A
Rating (non-repetitive, for t greater than 1 ms and less than 8.3 ms) for fusing	I^2t	840					A^2s
RMS isolation voltage from case to leads	V_{ISO}	2500					V
Operating junction storage temperature range	T_J, T_{STG}	-55 to 150					$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS (T _A = 25°C unless otherwise noted)								
PARAMETER	TEST CONDITIONS	SYMBOL	MTP35..A1					UNIT
			06	08	10	12	16	
Maximum instantaneous forward drop per diode	I _F = 17.5A	V _F	1.2					V
Maximum reverse DC current at rated DC blocking voltage per diod	T _A = 25°C	I _R	5					µA
	T _A = 150°C		1000					
Typical junction capacitance per diode	4V, 1MHz	C _J	300					pF

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	SYMBOL	MTP35..A1					UNIT
		06	08	10	12	16	
Typical thermal resistance	$R_{\theta JC}^{(1)}$	0.9					$^\circ\text{C/W}$

Notes

- (1) With heatsink
- (2) Bolt down on heatsink with silicone thermal compound between bridge and mounting surface for maximum heat transfer with #10 screw

ORDERING INFORMATION TABLE

Device code	MTP	35	10	A1
	①	②	③	④
	①	②	③	④
	①	②	③	④
	①	②	③	④

- ① - Module type: 3 phase Bridge
- ② - Current rating: $I_{F(AV)}$
- ③ - Voltage code x 100: V_{RRM}
- ④ - Package outline, A1 for "GBPC" package

Fig.1 Forward current derating curve

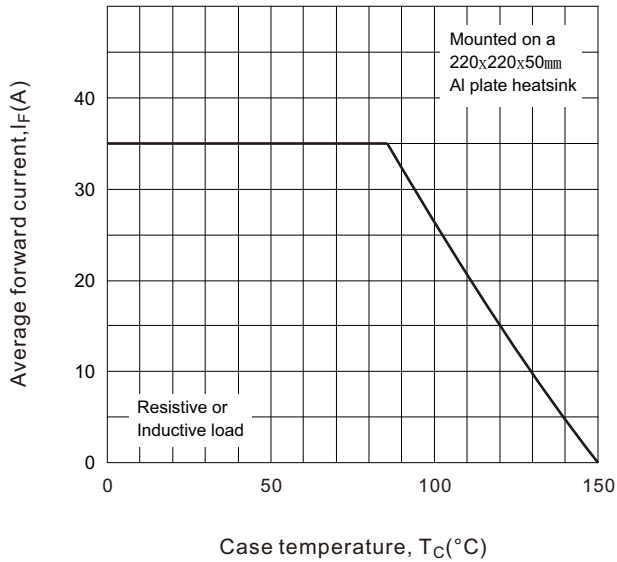


Fig.2 Typical forward characteristics

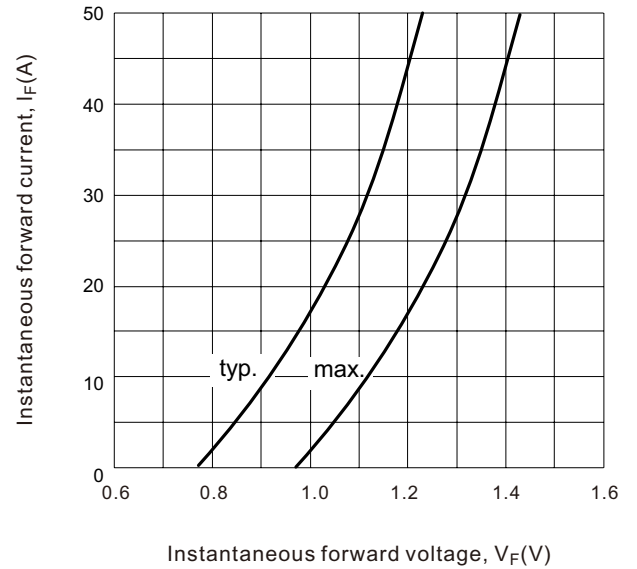


Fig.3 Max non-repetitive peak surge current

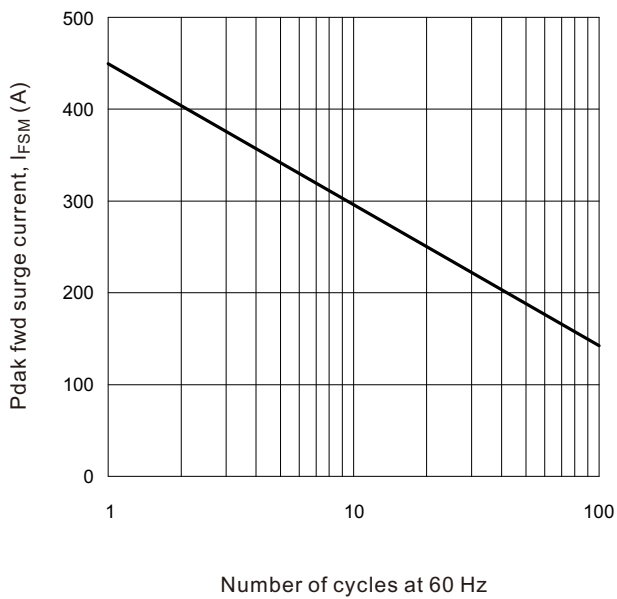


Fig.4 Transient thermal impedance

